

IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Tomoko HONGO et al.

Conf. 3419

Application No. 10/564,837

Group 1796

Filed April 17, 2006

Examiner Chun Cheng Wang

METAL COLLOID SOLUTION

AMENDMENT

Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

April 27, 2009

Sir:

In response to the Office Action mailed November 25, 2008, for which the period for response has been extended two months, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 11 of this paper.

An **Appendix** is attached following the signature page of this paper.